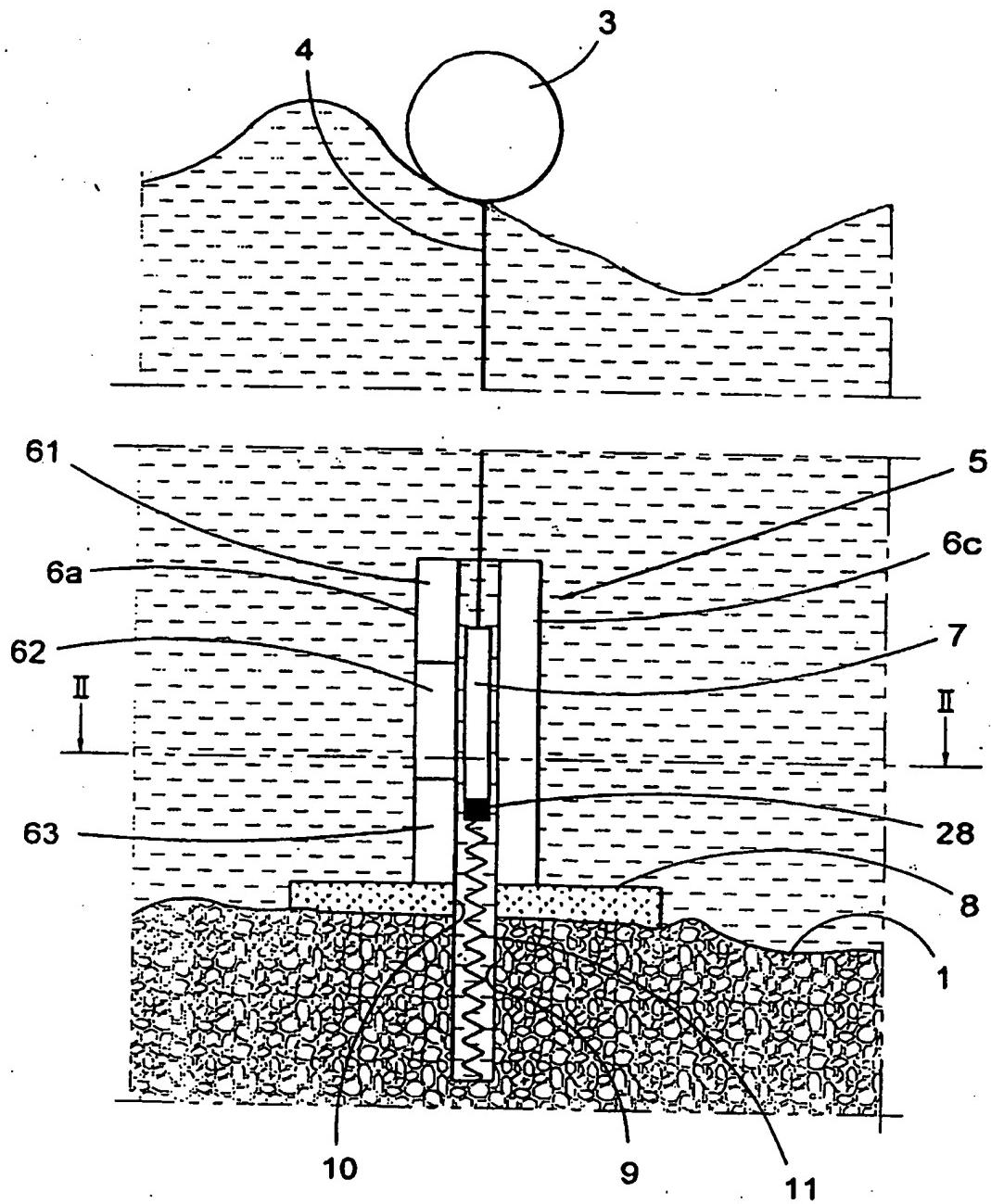


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Fig. 1

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Fig. 2

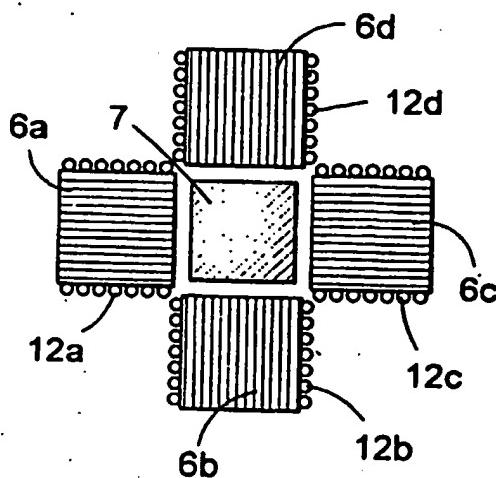


Fig. 4

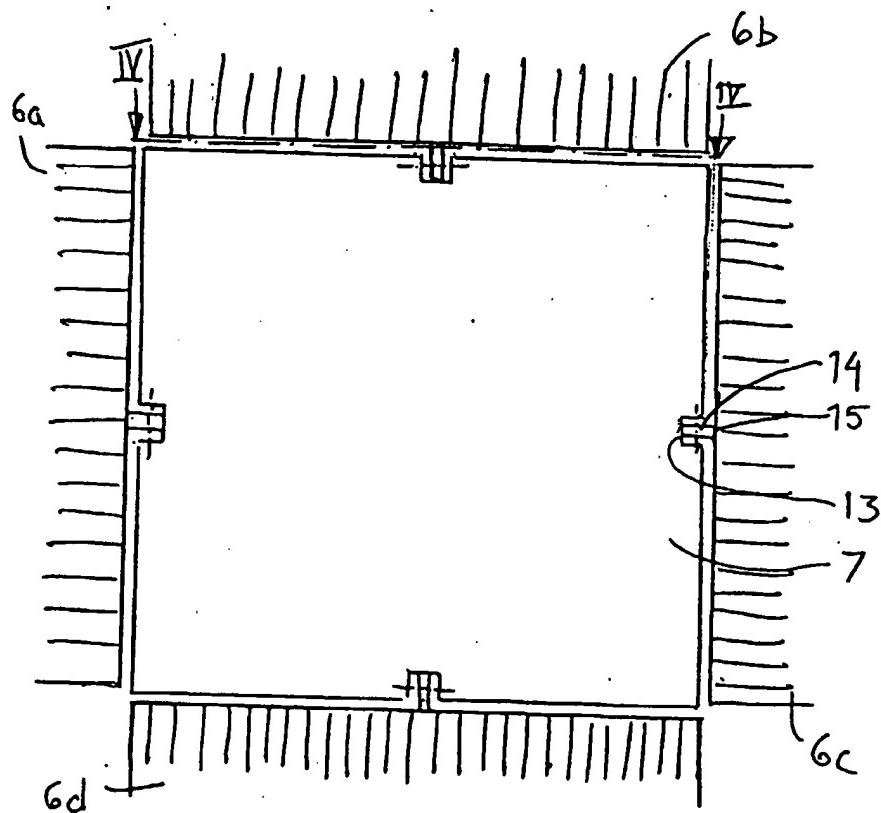
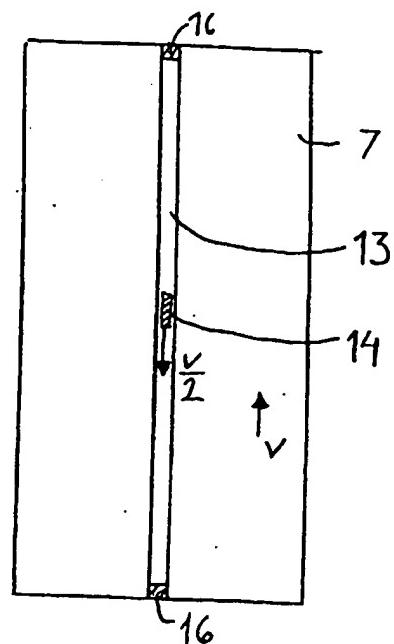


Fig. 3

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Fig. 5

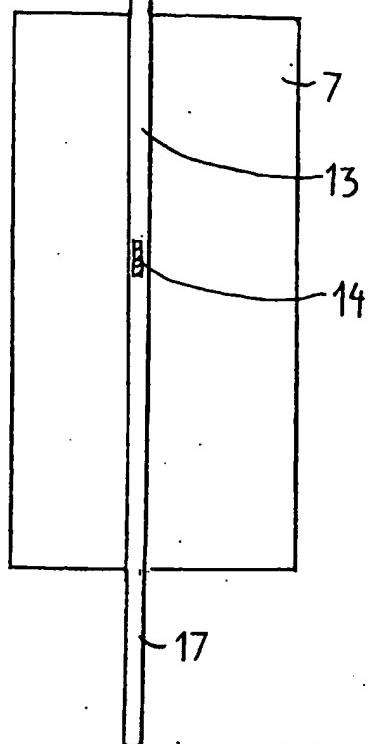


Fig. 6

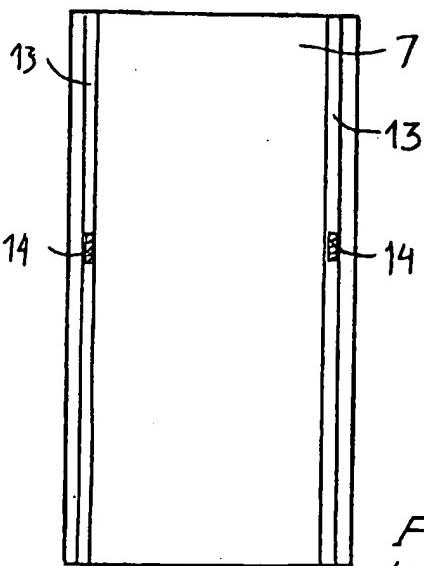
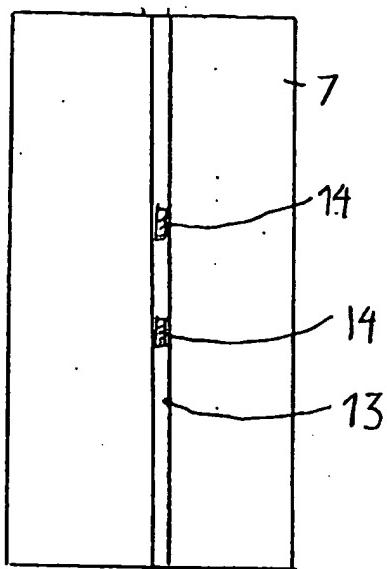


Fig. 7

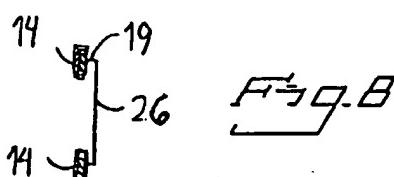


Fig. 8

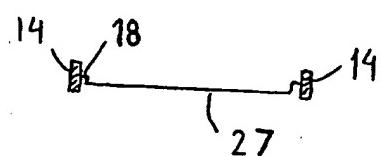


Fig. 9

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Fig. 10

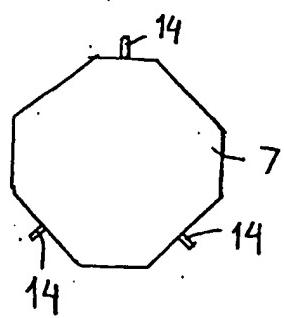


Fig. 11

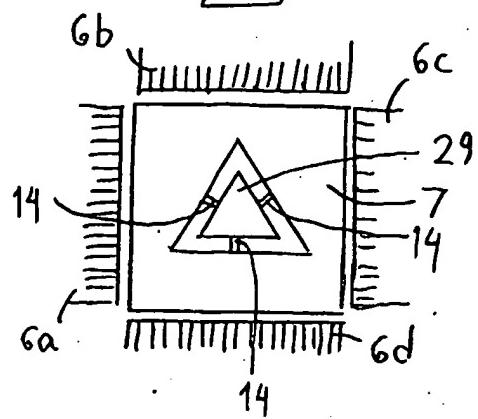


Fig. 12

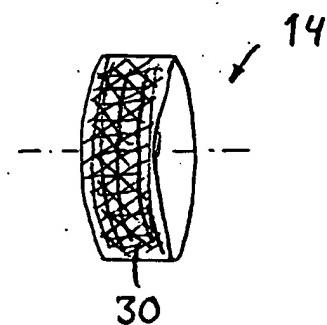


Fig. 13

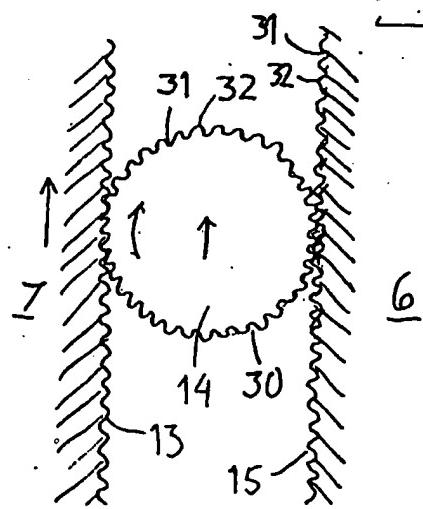


Fig. 14

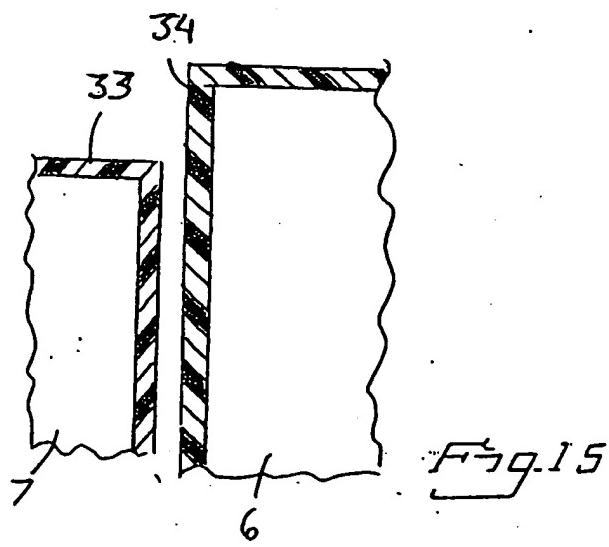
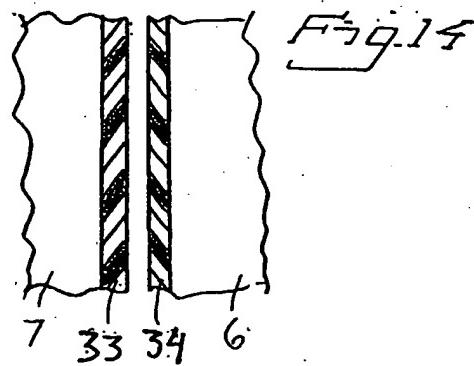


Fig. 15

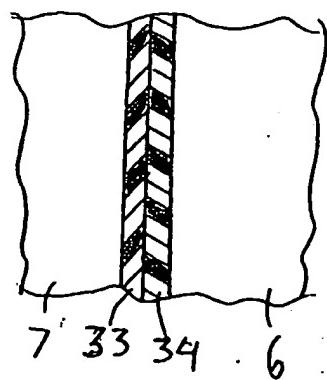


Fig. 16

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Fig. 18

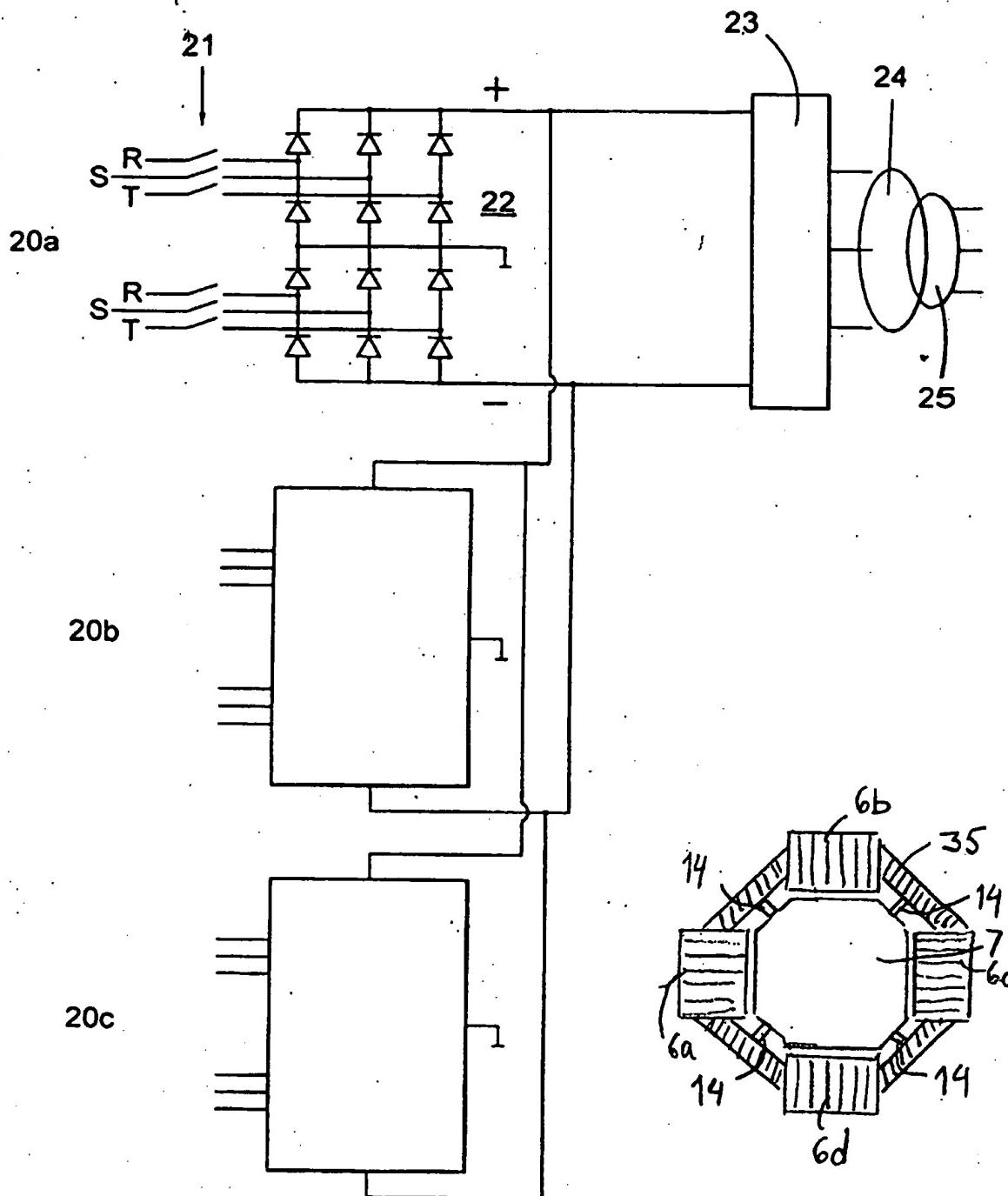


Fig. 17